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**ASIA INVESTMENT FINANCE GROUP LIMITED**

**亞投金融集團有限公司**

*(Incorporated in the Cayman Islands with limited liability)*

**(Stock Code: 33)**

**PROPOSED AMENDMENTS TO  
THE MEMORANDUM AND ARTICLES OF ASSOCIATION**

This announcement is made by Asia Investment Finance Group Limited (the “**Company**”) pursuant to Rule 13.51(1) of the Rules Governing the Listing of Securities on The Stock Exchange of Hong Kong Limited in relation to the proposed amendments to Memorandum and Articles of Association of Company (the “**Memorandum and Articles of Association**”).

The Board proposes to amend the Memorandum and Articles of Association with a view to:

- (i) expressly providing that the Directors may elect among themselves more than one person to act as Chairmen of the Board;
- (ii) reflecting the existing name of the Company;
- (iii) reflecting the latest authorised share capital of the Company; and
- (iv) making reference to the existing Companies Ordinance (chapter 622 of the laws of Hong Kong) and Companies Law (2016 Revision, cap. 22 of the laws of the Cayman Islands) instead of the predecessor ordinance or revision.

Details of the proposed amendments are set out in the circular of the Company and the Notice of Annual General Meeting both dated 24 May 2017.

By Order of the Board  
**Asia Investment Finance Group Limited**  
**Wei Jiafu**  
*Executive Director*

Hong Kong, 24 May 2017

*As at the date of this announcement, the Board comprises five executive Directors, namely Ms. Cheung Kwan, Mr. Wei Jiafu, Mr. Huang Shenglan, Mr. Cheng Wen and Mr. Wong Kwong Sum; and four Independent Non-executive Directors, namely Mr. Anthony Espina, Mr. Wong Tin Yau, Kelvin, Mr. Ge Ming and Mr. Ho Chun Chung, Patrick.*